501986021 07/12/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Masakazu Takemoto	07/01/2012
Yusuke Tsuchida	07/04/2012

RECEIVING PARTY DATA

Name:	SUMITOMO WIRING SYSTEMS, LTD.	
Street Address:	1-14, Nishisuehiro-cho	
City:	Yokkaichi-City, Mie	
State/Country:	JAPAN	
Postal Code:	510-8503	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13547147

CORRESPONDENCE DATA

 Fax Number:
 (212)725-2452

 Phone:
 201-847-5317

 Email:
 email@hpiplaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via

US Mail.

Correspondent Name: David W. Highet, VP & Chief IP Counsel B

Address Line 1: (Casella & Hespos)
Address Line 2: 1 Becton Drive, MC 110

Address Line 4: Franklin Lakes, NEW JERSEY 07417-1880

ATTORNEY DOCKET NUMBER:	FP12-074US
NAME OF SUBMITTER:	Gerald E. Hespos

Total Attachments: 2 source=12-074asn#page1.tif source=12-074asn#page2.tif

> PATENT REEL: 028534 FRAME: 0091

CH \$40.00 1354714

501986021

Atty. Ref.: FP12-074US

ASSIGNMENT

In consideration of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned by the Assignee, Sumitomo Wiring Systems, Ltd., a corporation organized under the laws of Japan, located at 1-14, Nishisuehiro-cho, Yokkaichi-City, Mie, 510-8503 Japan, receipt whereof is hereby acknowledged, the undersigned by these presents hereby sells, assigns, transfers and sets over unto the said assignee the entire right, title and interest in and to the invention or improvement entitled "CONNECTOR WITH ELECTRIC COMPONENT", said invention being fully described and/or claimed in the application for Letters Patent of the United States of America, executed this date, in and for the United States and all foreign countries, the same to be held and enjoyed by said assignee, its successors, assigns or other legal representatives, to the full ends of the terms for which all Letters Patent therefor may be granted, as fully and entirely as the same would have been held and enjoyed by the undersigned if this assignment and sale had not been made.

And Said Assignee Is Hereby Authorized to make application for and to receive Letters Patent for said invention in any of said countries at its election.

And By This Covenant The Undersigned will execute or procure any further necessary assurance of title to said invention and Letters Patent; and at any time, upon the request and at the expense of said assignee, will execute and deliver any and all papers that may be necessary or desirable to perfect the title to said invention or any Letters Patent which may be granted therefor to said Assignee, its successors, assigns or other legal representatives, and, upon the request and at the expense of said assignee, will execute any additional or divisional applications for patents for said invention, or any part or parts thereof, and for the reissue of any Letters Patent to be granted therefor, and will make all rightful oaths and do all lawful acts requisite for procuring the same or for aiding therein, without further compensation, but at the expense of said assignee, its successors, assigns or other legal representatives.

And The Commissioner Of Patents Is Hereby Authorized And Requested to issue any and all Letters Patent of the United States for said invention, to said assignee.

July 1, 2012	Masakazu Takemoto
Date	Masakazu Takemoto
Date	Yusuke Tsuchida

PATENT

REEL: 028534 FRAME: 0092

Atty. Ref.: FP12-074US

ASSIGNMENT

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And The Commissioner Of Patents Is Hereby Authorized And Requested to issuany and all Letters Patent of the United States for said invention, to said assignee.		
Date	Masakazu Takemoto	
July 4, 2012	Yusuke Tsuchida	
Date	Yusuke Tsuchida	

PATENT REEL: 028534 FRAME: 0093

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